EMH3 / UMH3N / IMH3A

NPN 100mA 50V Complex Digital Transistors (Bias Resistor Built-in Transistors)

Datasheet

Parameter	Tr1 and Tr2
V_{CEO}	50V
I _{C(MAX.)}	100mA
R_1	4.7kΩ

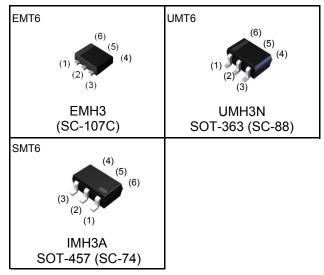
Features

- 1) Built-In Biasing Resistors.
- 2) Two DTC143T chips in one package.
- 3) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 4) The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- 5) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 6) Lead Free/RoHS Compliant.

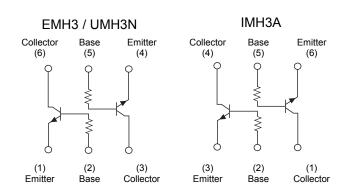
Application

Inverter circuit, Interface circuit, Driver circuit

Outline



●Inner circuit



Packaging specifications

Part No.	Package	Package size (mm)	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit (pcs)	Marking
EMH3	EMT6	1616	T2R	180	8	8,000	H3
UMH3N	UMT6	2021	TN	180	8	3,000	Н3
IMH3A	SMT6	2928	T110	180	8	3,000	Н3

● Absolute maximum ratings (Ta = 25°C)

<For Tr1 and Tr2 in common>

Paramete	Symbol	Values	Unit	
Collector-base voltage		V_{CBO}	50	V
Collector-emitter voltage		V_{CEO}	50	V
Emitter-base voltage		V _{EBO} 5		V
Collector current		I _{C(MAX.)} *1	100	mA
Collector Power dissipation EMH3 / UMH3N		P _D *2	150 (Total) ^{*3}	mW
IMH3A		$\Gamma_{\rm D}$	300 (Total) ^{*4}	mW
Junction temperature		T _j	150	°C
Range of storage temperature		T _{stg}	−55 to +150	°C

●Electrical characteristics(Ta = 25°C)

<For Tr1 and Tr2 in common>

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	50	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	-	-	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 50V	-	-	0.5	μΑ
Emitter cut-off current	I _{EBO}	V _{EB} = 4V	1	1	0.5	μА
Collector-emitter saturation voltage	V _{CE(sat)}	I _C / I _B = 5mA / 0.25mA	-	-	0.15	V
DC current gain	h _{FE}	V_{CE} = 5V , I_{C} = 1mA ,	100	250	600	-
Input resistance	R ₁	-	3.5	4.7	5.9	kΩ
Transition frequency	f _T *1	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference footprint

^{*3 120}mW per element must not be exceeded.

^{*4 200}mW per element must not be exceeded.

●Electrical characteristic curves(Ta = 25°C)

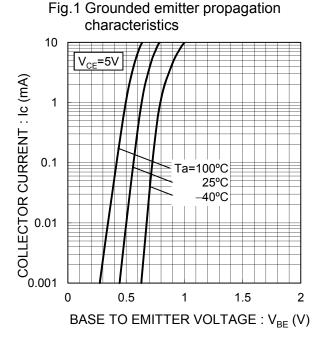


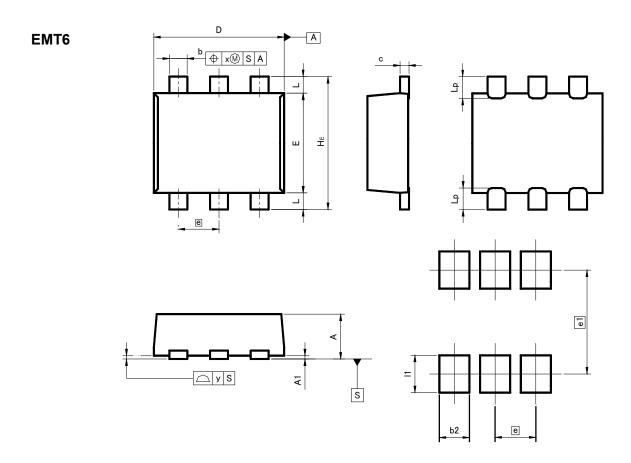
Fig.2 Grounded emitter output characteristics I_B= 500μA 100 Ta=25°C 450µA 400µA COLLECTOR CURRENT : I_C (mA) 80 350µA 300µA 60 250µA 200µA 40 150µA 100µA 20 50µA OA 0 0 5 10 **COLLECTOR TO EMITTER** VOLTAGE: V_{CF} (V)

Fig.3 DC Current gain vs. Collector Current 1k V_{CE}=5V 500 200 DC CURRENT GAIN: hFE Ta=100°C 100 25°C∰ 50 -40°C 20 10 5 2 100μ 200μ 500μ 1m 2m 5m 10m 20m 50m100m COLLECTOR CURRENT : I_C (mA)

vs. Collector Current $I_C/I_B=20$ 500m **COLLECTOR SATURATION** 200m Ta=100°C VOLTAGE: V_{CE}(sat) (V) 25°C 100m 50m 10m 5m 2m 5m 10m 20m COLLECTOR CURRENT : I_C (mA)

Fig.4 Collector-emitter saturation voltage

●Dimensions (Unit : mm)



Patterm of terminal position areas

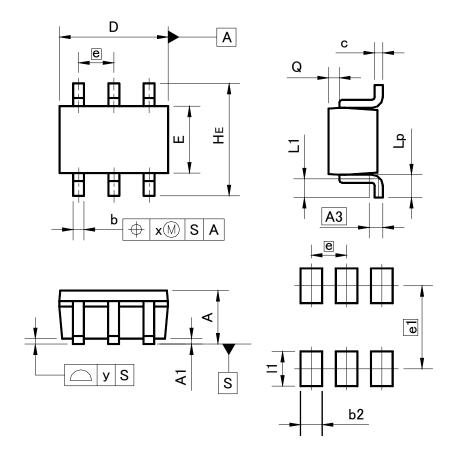
DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
A1	0.00	0.10	0	0.004	
Α	0.45	0.55	0.018	0.022	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.02		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	_	0.35		0.014	
х	_	0.10		0.004	
У	_	0.10	-	0.004	

DIM	MILIMI	MILIMETERS		HES
MIN		MAX	MIN	MAX
e1	1.25		0.049	
b2	_	- 0.37		0.015
l1	_	0.45	_	0.018

Dimension in mm/inches

●Dimensions (Unit : mm)

UMT6



Patterm of terminal position areas

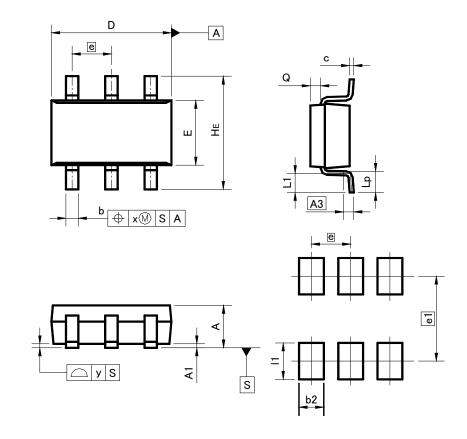
DIM MILIME		ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	1	0.039
A1	0.00	0.10	0	0.004
A3	0.2	25	0.0	01
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.03	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004
У	_	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
e1	1.55		0.06		
b2	- 0.40		ı	0.016	
l1	-	0.65	1	0.026	

Dimension in mm/inches

●Dimensions (Unit : mm)

SMT6



Patterm of terminal position areas

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α	1.00	1.30	0.039	0.051	
A1	0.00	0.10	0	0.004	
A3	0.3	25	0.0	01	
b	0.25	0.40	0.01	0.016	
С	0.09	0.25	0.004	0.01	
D	2.80	3.00	0.11	0.118	
E	1.50	1.80	0.059	0.071	
е	0.9	95	0.04		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.20	0.30	0.008	0.012	
х		0.20		0.008	
У	-	0.10		0.004	

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
e1	2.10		0.08		
b2	0.60		_	0.024	
l1	-	0.90	1	0.035	

Dimension in mm/inches

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